	Search Text	DBs	Time Stamp
<u> </u>	organoclay and electroconductive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02
Ν	clay and intercalate and electroconductive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/02 09:54
ω	"6025119"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02 09:58
4	(("5853886") or ("5804613") or ("5786417") or ("5760121") or ("578624") or ("5521306") or ("5554670") or ("5552469") or ("5428094") or ("5391437") or ("5102948") or ("5164440") or ("5102948") or ("4889885") or ("4894411") or ("4739007") or ("4472538") or ("4379007")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02 10:08
5	adhesive and exfoliate and clay	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02 10:09
0	adhesive and exfoliat\$3 and clay	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02 10:09
7	((adhesive and exfoliate and clay) or (adhesive and exfoliat\$3 and clay)) and conductive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02 10:23
8	"6060230"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02 11:24
9	"6214460"	; US-PGPUB; JPO; NT; IBM_TDB	2003/06/02 10:40
10	clay and intercalat\$3 and adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/02 10:41

	Search Text
11	(clay and intercalat\$3 adhesive) and conducti
12	524/445
13	(524/445).CCLS.
14	(524/186).CCLS.
15	(524/447).CCLS.
16	(524/446).CCLS.
17	(524/450).CCLS.
18	(450/530).CCLS.
19	(450/527).CCLS.